Power Transistors

Panasonic

2SD1275, 2SD1275A

Silicon NPN triple diffusion planar type darlington

For power amplification

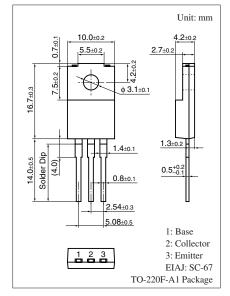
Complementary to 2SB0949 and 2SB0949A

Features

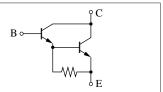
- \bullet High forward current transfer ratio h_{FE}
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SD1275	V _{CBO}	60	V
(Emitter open)	2SD1275A		80	
Collector-emitter voltage	2SD1275	V _{CEO}	60	V
(Base open)	2SD1275A		80	
Emitter-base voltage (Coll	V _{EBO}	5	V	
Collector current	I _C	2	А	
Peak collector current	I _{CP}	4	А	
Collector power	$T_C = 25^{\circ}C$	P _C	35	W
dissipation		2.0		
Junction temperature	Tj	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	



Internal Connection



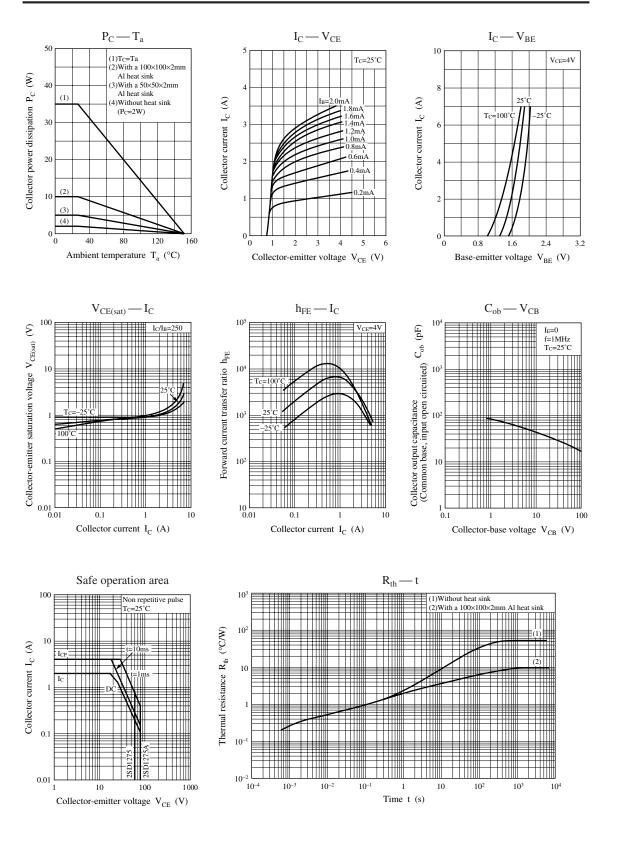
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SD1275	V _{CEO}	$I_{\rm C} = 30 \text{ mA}, I_{\rm B} = 0$	60			V
(Base open)	2SD1275A			80			
Base-emitter voltage		V _{BE}	$V_{CE} = 4 V, I_C = 2 A$			2.8	V
Collector-base cutoff	2SD1275	I _{CBO}	$V_{CB} = 60 \text{ V}, I_E = 0$			1	mA
current (Emitter open)	2SD1275A		$V_{CB} = 80 V, I_E = 0$			1	
Collector-emitter cutoff	2SD1275	I _{CEO}	$V_{CE} = 30 \text{ V}, I_B = 0$			2	mA
current (Base open)	2SD1275A		$V_{CE} = 40 \text{ V}, I_B = 0$			2	
Emitter-base cutoff current (Collector open)		I _{EBO}	$V_{EB} = 5 V, I_C = 0$			2	mA
Forward current transfer ratio		h _{FE1}	$V_{CE} = 4 V, I_C = 1 A$	1 0 0 0			_
		h _{FE2} *	$V_{CE} = 4 V, I_C = 2 A$	1 0 0 0		10 000	
Collector-emitter saturation voltage		V _{CE(sat)}	$I_{\rm C} = 2 \text{ A}, I_{\rm B} = 8 \text{ mA}$			2.5	V
Transition frequency		f _T	$V_{CE} = 10 \text{ V}, I_C = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time		ton	$I_C = 2 A, I_{B1} = 8 mA, I_{B2} = -8 mA,$		0.5		μs
Storage time		t _{stg}	$V_{CC} = 50 V$		4.0		μs
Fall time		t _f			1.0		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Rank classification

Rank	R	Q	Р
h _{FE2}	1 000 to 2 500	2000 to 5000	4000 to 10000

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